

13A 500V N-channel Enhancement Mode Power MOSFET

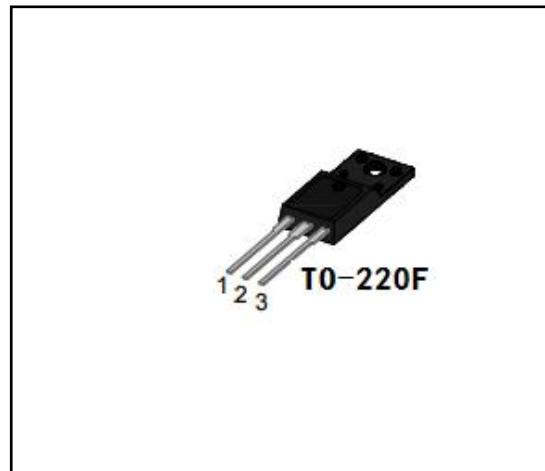
1 Description

These N-channel enhanced vdmosfets, is obtained by the self-aligned planar technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. Which accords with the RoHS standard. TO-220F provides insulation voltage rated at 2000V RMS from all three terminals to external heatsink. TO-220F series comply with UL standards (File ref:E252906).

| | |
|--|--|
| | $V_{DSS} = 500V$ $I_D = 13.0A$ $R_{DS(on)} \text{ (TYP)} = 0.35\Omega$ |
|--|--|

2 Features

- Fast switching
- ESD improved capability
- Low on resistance($R_{DS(on)} \leq 0.45\Omega$)
- Low gate charge(Typ: 40nC)
- Low reverse transfer capacitances(Typ: 11pF)
- 100% single pulse avalanche energy test
- 100% ΔV_{DS} test



3 Applications

- Used in various power switching circuit for system miniaturization and higher efficiency.
- Power switch circuit of electron ballast and adaptor.

4 Electrical Characteristics

4.1 Absolute Maximum Ratings ($T_c=25^\circ C$, unless otherwise noted)

| PARAMETER | | SYMBOL | VALUE | UNIT |
|--|--|-----------|----------|------|
| Drain-Source Voltage | | V_{DS} | 500 | V |
| Gate-Source Voltage | | V_{GS} | ± 30 | V |
| Drain Current(continuous) ^(Note 3) | | I_D | 13 | A |
| Drain Current(continuous)($T=100^\circ C$) ^(Note 3) | | I_D | 8.2 | A |
| Drain Current(Pulsed) | | I_{DM} | 52 | A |
| Single Pulse Avalanche Energy ^(Note 4) | | E_{AS} | 845 | mJ |
| Derating Factor above $T_a=25^\circ C$ | | P_D | 0.34 | W |
| Power Dissipation $T_c=25^\circ C$ | | | 42 | W |
| Operating Junction Temperature Range | | T_j | -55~150 | °C |
| Storage Temperature Range | | T_{stg} | -55~150 | °C |
| High Temperature(tin solder) | | T_L | 300 | °C |

4.2 Thermal Characteristics

| PARAMETER | | SYMBOL | VALUE | UNIT |
|---|--|------------|-------|------|
| Thermal Resistance, Junction to Case-sink | | R_{thJC} | 2.98 | °C/W |
| Thermal Resistance, Junction to Ambient | | R_{thJA} | 62.5 | °C/W |

4.3 Electrical Characteristics (T_c=25°C, unless otherwise noted)

| PARAMETER | SYMBOL | Test Condition | VALUE | | | UNIT |
|--|---------------------|---|-------|------|------|------|
| | | | MIN | TYP | MAX | |
| Off Characteristics | | | | | | |
| Drain-source Breakdown Voltage | BV _{DSS} | I _D =250μA,V _{GS} =0V | 500 | -- | -- | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =500V,V _{GS} =0V, T _C =25°C | -- | -- | 1 | μA |
| | | V _{DS} =400V,V _{GS} =0V, T _C =125°C | -- | -- | 100 | μA |
| Gate-to-Body Leakage Current | I _{GSS} | V _{GS} =±30V,V _{DS} =0V | -- | -- | ±100 | nA |
| On Characteristics ^(Note 3) | | | | | | |
| Gate threshold voltage | V _{GS(th)} | V _{DS} =V _{GS} ,I _D =250μA | 2.0 | -- | 4.0 | V |
| Drain-source on Resistance | R _{DS(on)} | V _{GS} =10V,I _D =6.5A | -- | 0.35 | 0.45 | Ω |
| Dynamic Characteristics | | | | | | |
| Input Capacitance | C _{iss} | V _{GS} =0V,V _{DS} =25V, f=1.0MHz | -- | 1957 | 2544 | pF |
| Output Capacitance | C _{oss} | | -- | 195 | 254 | |
| Reverse Transfer Capacitance | C _{rss} | | -- | 44 | 57.5 | |
| Turn-on Delay Time | T _{d(on)} | ID=13A, VDD=250V, VGS=10V, RG=10Ω | -- | 28 | -- | ns |
| Turn-on Rise Time | t _r | | -- | 21 | -- | |
| Turn-off Delay Time | T _{d(off)} | | -- | 62 | -- | |
| Turn-off Fall | t _f | | -- | 32 | -- | |
| Total Gate Charge | Q _g | ID=13A, VDD=400V, VGS=10V | -- | 40 | -- | nc |
| Gate-to-Source Charge | Q _{gs} | | -- | 9.2 | -- | |
| Gate-to-Drain("Miller")C harge | Q _{gd} | | -- | 14 | -- | |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage ^(Note 3) | V _{FSD} | V _{GS} =0V,I _s =13A | -- | -- | 1.5 | V |
| Continuous Source Current (BodyDiode) ^(Note 3) | I _s | | -- | -- | 13 | A |
| Reverse Recovery Time | trr | T _J =25°C ,IF=13A, dIF/dt=100A/μS,VGS=0V | -- | 520 | -- | ns |
| Reverse Recovery Charge | Qrr | | -- | 4500 | -- | nc |

Notes:

1: Repetitive rating, pulse width limited by maximum junction temperature.

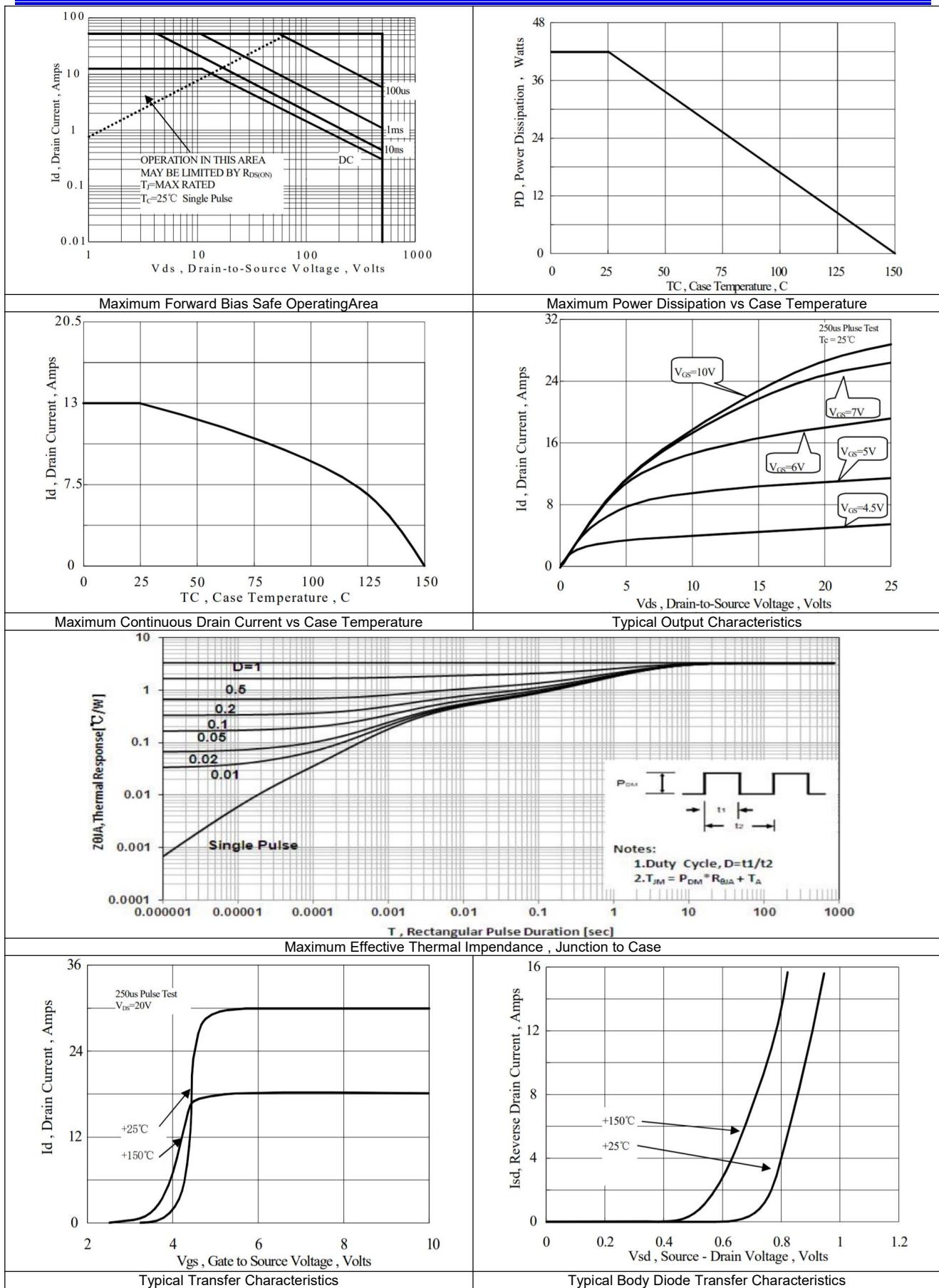
2: Surface mounted on FR4 Board, t≤10sec.

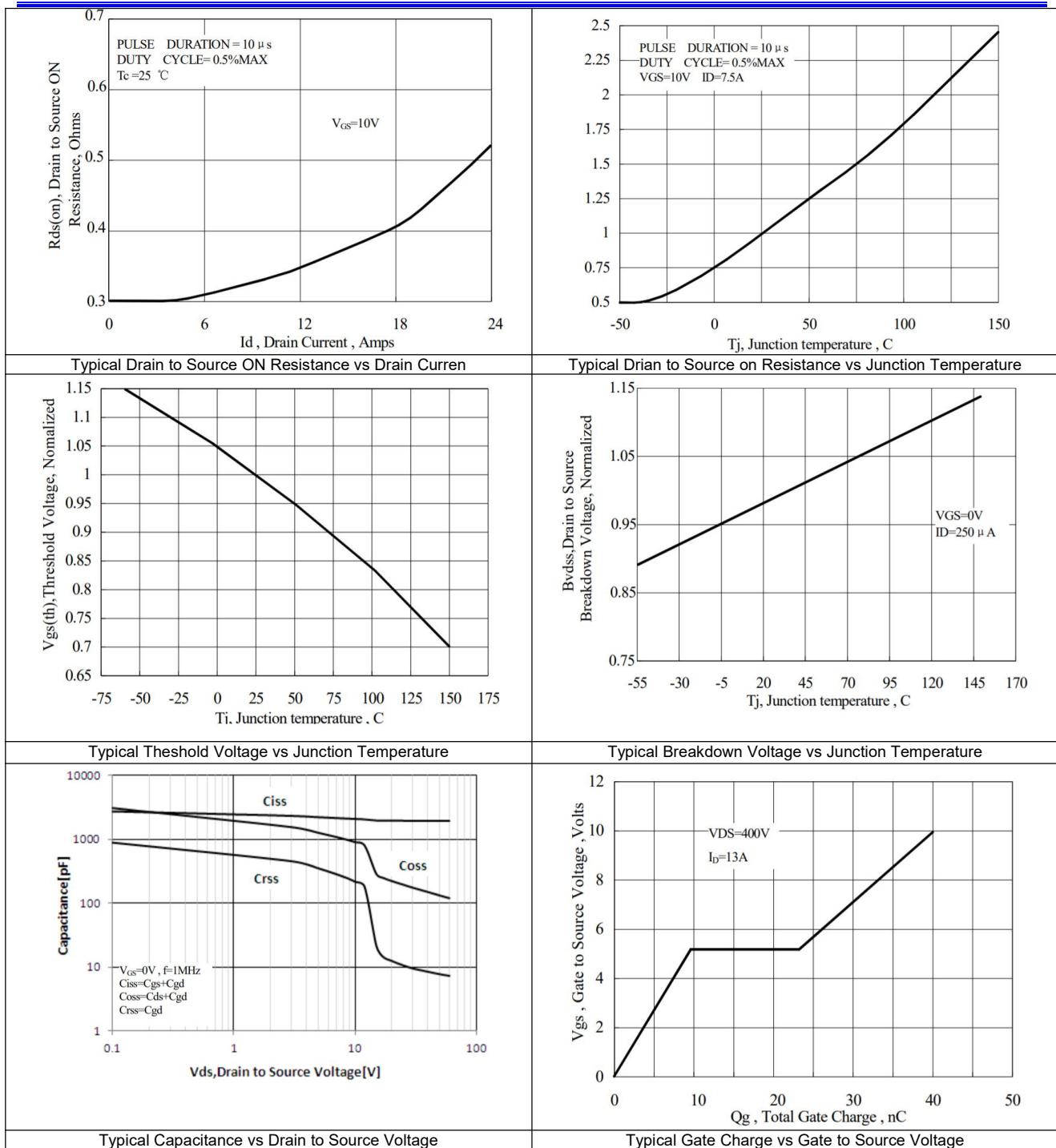
3: Pulse width ≤ 300μs, duty cycle ≤ 2%.

4: L=10mH,I_D=13A,V_{DD}=50V,,Start T_J=25°C.

5 Typical Test Circuit and Waveform

| | |
|--|--|
| | |
| | |
| | |
| | |



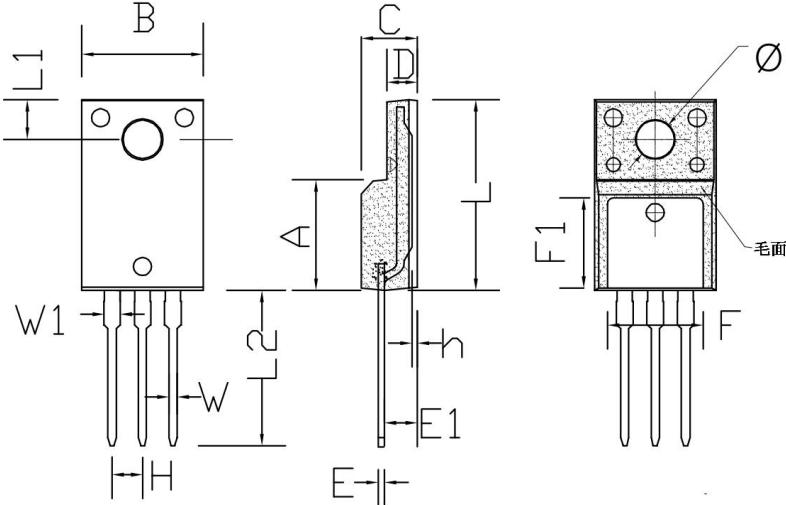


6 Product Specifications and Packaging Models

| Product Model | Package Type | Mark Name | RoHS | Package | Quantity |
|---------------|--------------|-----------|---------|---------|----------|
| F13N50 | TO-220F | F13N50 | Pb-free | Tube | 1000/box |

7 Dimensions

TO-220F PACKAGE OUTLINE DIMENSIONS



| Symbol | DimensionsIn Millimeters | | DimensionsIn Inches | |
|--------|--------------------------|-------|---------------------|-------|
| | min. | max. | min. | max. |
| A | 8.80 | 9.30 | 0.346 | 0.366 |
| B | 10.00 | 10.50 | 0.394 | 0.413 |
| C | 4.30 | 4.90 | 0.169 | 0.193 |
| D | 2.30 | 2.70 | 0.091 | 0.106 |
| L | 15.55 | 16.15 | 0.612 | 0.636 |
| h | 0.40 | 0.60 | 0.016 | 0.024 |
| L1 | 3.15 | 3.55 | 0.124 | 0.140 |
| L2 | 12.65 | 13.35 | 0.498 | 0.526 |
| W | 0.70 | 0.90 | 0.028 | 0.035 |
| W1 | 1.15 | 1.55 | 0.045 | 0.061 |
| H | 2.54 TYP | | 0.100 TYP | |
| E | 0.48 | 0.53 | 0.019 | 0.021 |
| Φ | 2.90 | 3.40 | 0.114 | 0.134 |
| E1 | 2.40 | 2.90 | 0.094 | 0.114 |
| F | 7.75 | 8.25 | 0.305 | 0.325 |
| F1 | 7.35 | 7.85 | 0.289 | 0.309 |

8 Atentions

- Jiangsu Donghai Semiconductor Technology Co., Ltd. reserves the right to change the specification without prior notice! The customer should obtain the latest version of the information before making the order and verify that the information is complete and up to date.
- It is the responsibility of the purchaser for any failure or failure of any semiconductor product under certain conditions. It is the responsibility of the purchaser to comply with safety standards and to take safety measures in the system design and machine manufacturing of Wxdh products in order to avoid potential risk of failure. Injury or property damage.
- Product promotion is endless, our company will be dedicated to provide customers with better products.

9 Appendix

Revision history:

| Date | REV. | Description | Page |
|------------|------|-------------------------------|--------|
| 2020.03.09 | 1.0 | Original | |
| 2022.12.28 | 1.1 | Added capacitance upper limit | 2 page |

